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sing Fairch	nild Semicon	OSFET has been designed ductor's advanced Power the $R_{DS(ON)} @ V_{GS} = 2.5v.$	• 200 m	$ \begin{array}{l} A, 20 \ V R_{DS(ON)} = \ 5 \ \Omega \ \textcircled{O} \ V_G \\ \\ R_{DS(ON)} = \ 7 \ \Omega \ \textcircled{O} \ V_G \end{array} $	
pplicatio	ns	V.FRER.	• ESD p	protection diode (note 3)	
Li-Ion Batte	ery Pack		• RoHS	Compliant	
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	te Maxim	num Ratings T _{A=25°C u}	nless otherwise noted	S 2) 3 D
Absolu Symbol		num Ratings T _{A=25°C u} Parameter	nless otherwise noted	Ratings	/ Units
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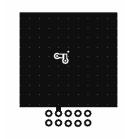
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FDY301NZ Single N-Channel 2.5V Specified PowerTrench[®] MOSFET

January 2006

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics				11	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0~V, \qquad I_{D}=250~\mu A$	20			V
<u>ΔBV_{DSS}</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 16 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
I _{GSS}	Gate-Body Leakage,				± 10 ± 1	μA μA
On Char	acteristics (Note 2)			•		
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.6	-	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25 C		2.8		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS}=4.5 \ V, & I_{D}=200 \ mA \\ V_{GS}=2.5 \ V, & I_{D}=175 \ mA \\ V_{GS}=1.8 \ V, & I_{D}=150 \ mA \\ V_{GS}=1.5 \ V, & I_{D}=20 \ mA \\ V_{GS}=4.5 \ V, \ I_{D}=200 \ mA, \ T_{J}=125^{\circ}C \end{array} $			5 7 9 10 7	Ω
g FS	Forward Transconductance	$V_{DS} = 5 \text{ V}, \qquad I_D = 200 \text{ mA}$		1.1		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$		60		pF
Coss	Output Capacitance	f = 1.0 MHz		20		pF
C _{rss}	Reverse Transfer Capacitance			10		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V$, $I_D = 1 A$,		6	12	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$		8	16	ns
t _{d(off)}	Turn-Off Delay Time			8	16	ns
t _f	Turn-Off Fall Time			2.4	4.8	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, \qquad I_D = 200 \text{ mA},$		0.8	1.1	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		0.16		nC
Q _{gd}	Gate-Drain Charge			0.26		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 150 \text{ mA} \text{ (Note 2)}$		0.7	1.2	V
t _{rr}	Diode Reverse Recovery Time	I _F = 200 mA,		12		nS
		dI _F /dt = 100 A/µs				

the drain pins. $\rm R_{BJC}$ is guaranteed by design while $\rm R_{BCA}$ is determined by the user's board design.



a)	200 °C/W when mounted on a 1 in ² pad of 2 oz copper

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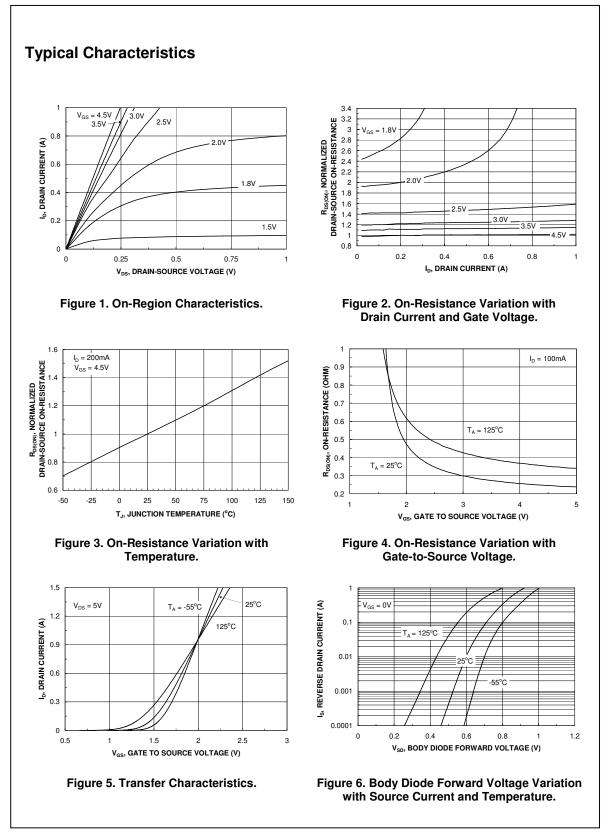
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b) 280 °C/W when mounted on a minimum pad of 2 oz copper Scale 1 : 1 on letter size paper

- 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%
- The diode connected between the gate and source serves only as protection againts ESD. No gate overvoltage rating is implied.

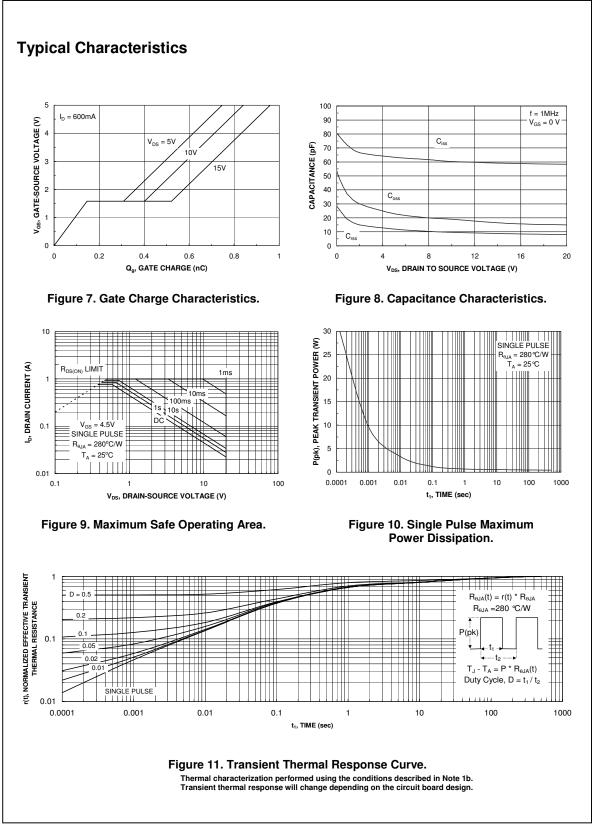
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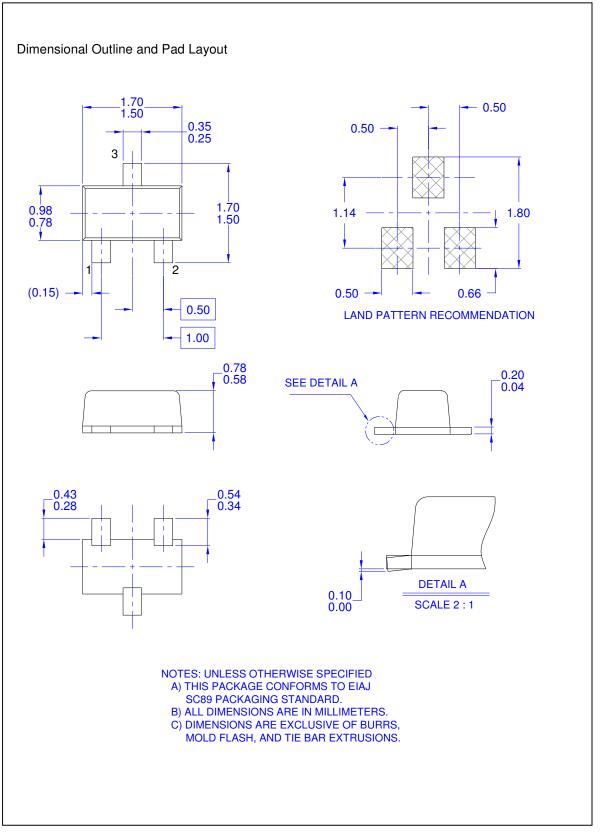


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